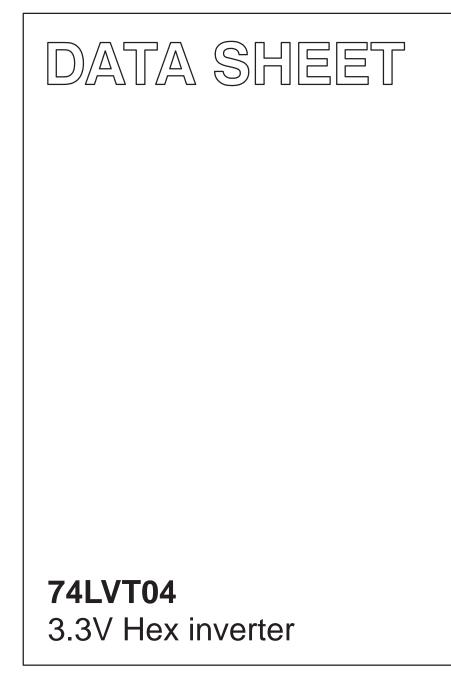
INTEGRATED CIRCUITS



Product specification IC24 Data Handbook

1996 Aug 28



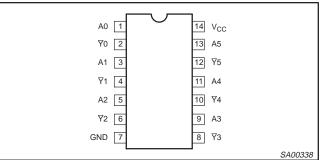
Philips Semiconductors

74LVT04

QUICK REFERENCE DATA

SYMBOL	$\begin{array}{c} \mbox{CONDITIONS} \\ \mbox{PARAMETER} & T_{amb} = 25^{\circ}\mbox{C}; \\ \mbox{GND} = 0\mbox{V} \end{array}$		TYPICAL	UNIT
t _{PLH} t _{PHL}	Propagation delay An to Yn	$V_{L} = 50 \text{ pr};$		ns
C _{IN}	Input capacitance	V _I = 0V or 3.0V	3	pF
I _{CCL}	Total supply current	Outputs Low; $V_{CC} = 3.6V$	1.5	mA

PIN CONFIGURATION



PIN DESCRIPTION

PIN NUMBER	SYMBOL	NAME AND FUNCTION
1, 3, 5, 9, 11, 13	An	Data inputs
2, 4, 6, 8, 10, 12	Ϋ́n	Data outputs
7	GND	Ground (0V)
14	V _{CC}	Positive supply voltage

FUNCTION TABLE

INPUTS	OUTPUT	
An	Yn	
L	Н	
Н	L	

NOTES:

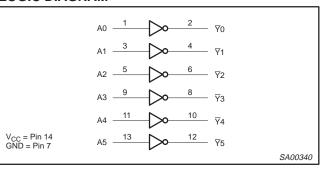
H = High voltage level

L = Low voltage level

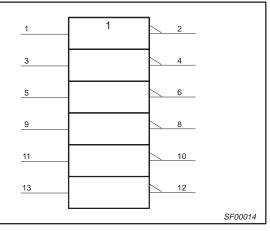
ORDERING INFORMATION

PACKAGES TEMPERATURE		OUTSIDE NORTH AMERICA	NORTH AMERICA	DWG NUMBER
14-Pin Plastic SO	-40°C to +85°C	74LVT04 D	74LVT04 D	SOT108-1
14-Pin Plastic SSOP	-40°C to +85°C	74LVT04 DB	74LVT04 DB	SOT337-1
14-Pin Plastic TSSOP	–40°C to +85°C	74LVT04 PW	74LVT04PW DH	SOT402-1

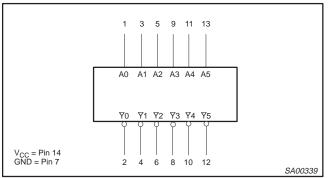
LOGIC DIAGRAM



LOGIC SYMBOL (IEEE/IEC)



LOGIC SYMBOL



74LVT04

ABSOLUTE MAXIMUM RATINGS^{1, 2}

SYMBOL	PARAMETER	PARAMETER CONDITIONS		UNIT	
V _{CC}	DC supply voltage		-0.5 to +4.6	V	
I _{IK}	DC input diode current	V ₁ < 0	-50	mA	
VI	DC input voltage ³		-0.5 to +7.0	V	
I _{OK}	DC output diode current	V _O < 0	-50	mA	
V _{OUT}	DC output voltage ³	Output in Off or High state	-0.5 to +7.0	V	
		Output in High state			
IOUT	DC output current	Output in Low state	64	mA	
T _{stg}	Storage temperature range		-65 to 150	°C	

NOTES:

1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

2. The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction

The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIM	UNIT	
STWBOL	PARAMETER	MIN	MAX	UNIT
V _{CC}	DC supply voltage	2.7	3.6	V
VI	Input voltage	0	5.5	V
V _{IH}	High-level input voltage			V
V _{IL}	Low-level Input voltage		0.8	V
I _{ОН}	High-level output current		-20	mA
I _{OL}	Low-level output current		32	mA
Δt/Δv	Input transition rise or fall rate; Outputs enabled		10	ns/V
T _{amb}	Operating free-air temperature range	-40	+85	°C

74LVT04

DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions Voltages are referenced to \vec{GND} (ground = 0V)

			LIMITS Temp = -40°C to +85°C			UNIT		
SYMBOL	PARAMETER	TEST CONDITIONS						
			MIN TYP ¹ MA	МАХ	1			
V _{IK}	Input clamp voltage	$V_{CC} = 2.7V; I_{IK} = -18mA$			-1.2	V		
		$V_{CC} = 2.7$ to 3.6V; $I_{OH} = -100\mu A$	V _{CC} -0.2					
V _{OH}	High-level output voltage	$V_{CC} = 2.7V; I_{OH} = -6mA$	2.4			V		
		$V_{CC} = 3.0V; I_{OH} = -20mA$	2.0					
V _{OL}		V _{CC} = 2.7V; I _{OL} = 100μA			0.2	v		
	Low-level output voltage	V _{CC} = 2.7V; I _{OL} = 24mA			0.5			
		V _{CC} = 3.0V; I _{OL} = 32mA			0.5			
	V _{CC} = 0 or 3.6V; V _I = 5.5V				10			
I _I	Input leakage current	$V_{CC} = 3.6V; V_I = V_{CC} \text{ or } GND$	±1			μA		
I _{OFF}	Output off current	$V_{CC} = 0V; V_{I} \text{ or } V_{O} = 0 \text{ to } 4.5V$			±100	μA		
I _{CCH}		V_{CC} = 3.6V; Outputs High, V_{I} = GND or V_{CC}, I_{O} = 0			0.02			
I _{CCL}	Quiescent supply current	V_{CC} = 3.6V; Outputs Low, V_{I} = GND or $V_{CC,}$ I_{O} = 0		1.5	3	mA		
ΔI_{CC}	Additional supply current per input pin ²	V_{CC} = 3V to 3.6V; One input at V_{CC} = 0.6V, Other inputs at V_{CC} or GND			0.2	μΑ		
CI	Input capacitance	$V_1 = 3V \text{ or } 0$		3		pF		

NOTES:

1. All typical values are at $V_{CC} = 3.3V$ and $T_{amb} = 25^{\circ}C$. 2. This is the increase in supply current for each input at the specificed voltage level other than V_{CC} or GND.

AC CHARACTERISTICS

GND = 0V; $t_R = t_F = 2.5ns$; $C_L = 50pF$, $R_L = 500\Omega$; $T_{amb} = -40^{\circ}C$ to +85°C.

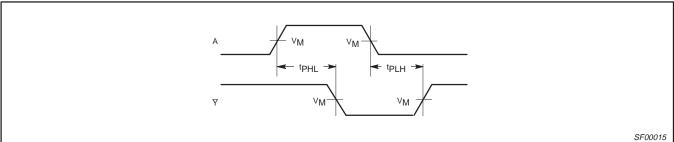
SYMBOL	PARAMETER	WAVEFORM	Vcc	$_{ m c}$ = 3.3V \pm 0	.3V	$V_{CC} = 2.7 V$	UNIT
			MIN	TYP ¹	MAX	MAX	
t _{PLH} t _{PHL}	Propagation delay An to Yn	1	1.0 1.0	2.6 2.5	3.9 3.5	4.7 3.2	ns

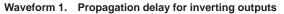
NOTE:

1. All typical values are at V_{CC} = 3.3V and T_{amb} = 25°C.

AC WAVEFORMS

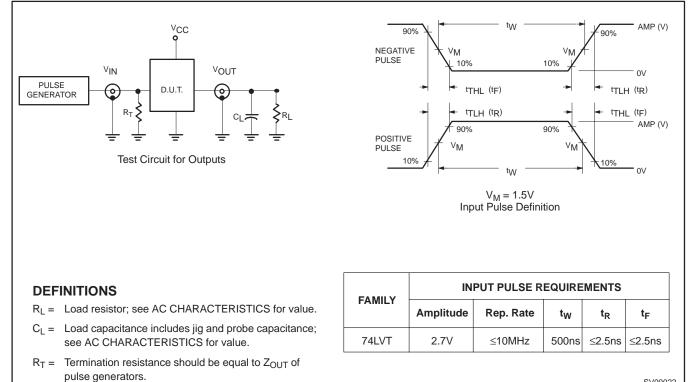
 V_{M} = 1.5V, V_{IN} = GND to 2.7V





74LVT04

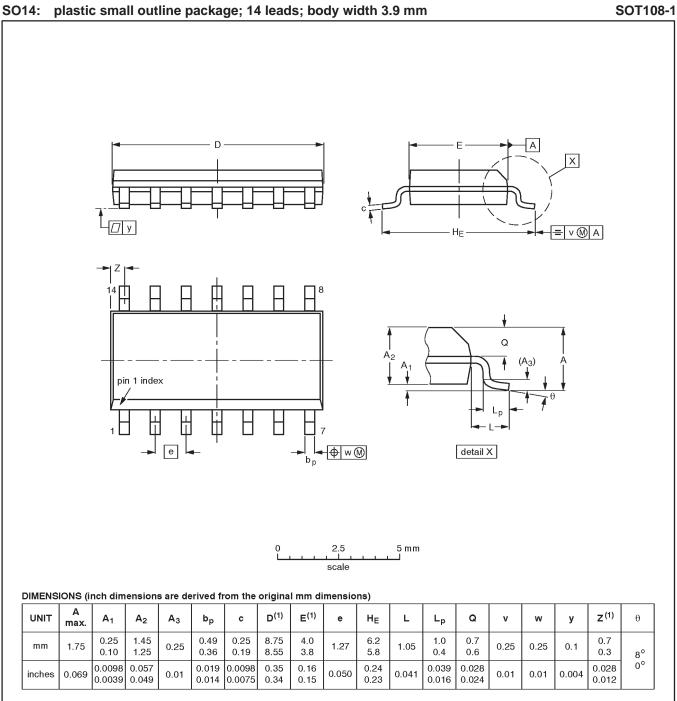
TEST CIRCUIT AND WAVEFORMS



SV00022

74LVT04

Product specification



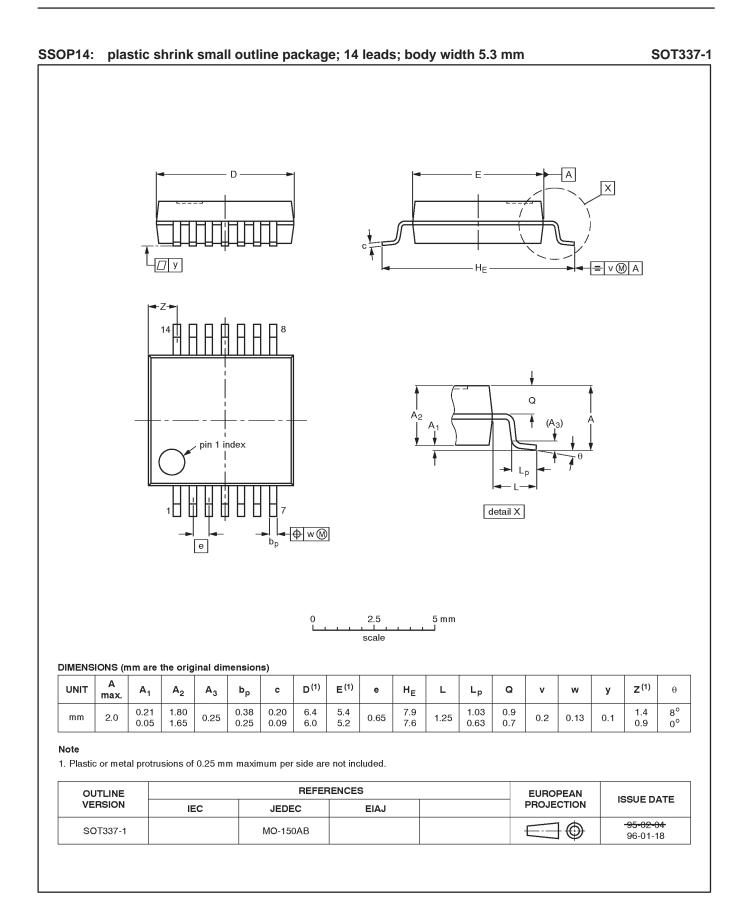
Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE		REFERENCES				ISSUE DATE
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT108-1	076E06S	MS-012AB				91-08-13 95-01-23

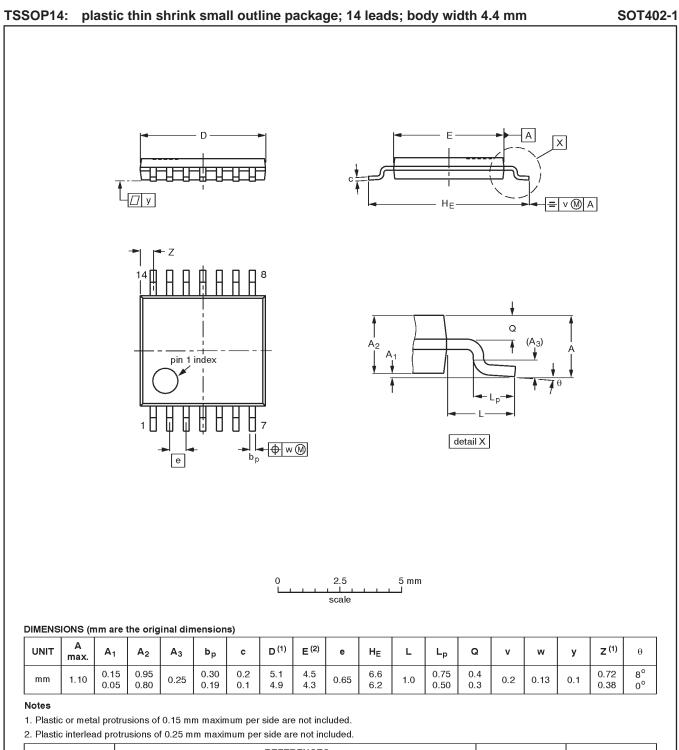
Product specification

74LVT04



Product specification

74LVT04



OUTLINE	REFERENCES				EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ		PROJECTION	1550E DATE
SOT402-1		MO-153				-94-07-12 95-04-04

74LVT04

NOTES

74LVT04

DEFINITIONS			
Data Sheet Identification Product Status		Definition	
Objective Specification	Formative or in Design	This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice.	
Preliminary Specification	Preproduction Product	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.	
Product Specification	Full Production	This data sheet contains Final Specifications. Philips Semiconductors reserves the right to make changes at any time without notice, in order to improve design and supply the best possible product.	

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